

# 2SK1153, 2SK1154

# Silicon N Channel MOS FET

REJ03G0908-0200

(Previous: ADE-208-1246)

Rev.2.00 Sep 07, 2005

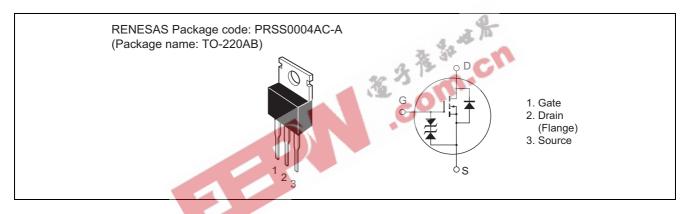
## **Application**

High speed power switching

#### **Features**

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

#### **Outline**



# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

| Item                        |                           | Symbol                   | Ratings     | Unit |
|-----------------------------|---------------------------|--------------------------|-------------|------|
| Drain to source voltage     | to source voltage 2SK1153 |                          | 450         | V    |
|                             | 2SK1154                   |                          | 500         |      |
| Gate to source voltage      |                           | $V_{GSS}$                | ±30         | V    |
| Drain current               |                           | I <sub>D</sub>           | 3           | А    |
| Drain peak current          |                           | I <sub>D(pulse)</sub> *1 | 12          | А    |
| Body to drain diode reverse | drain current             | I <sub>DR</sub>          | 3           | А    |
| Channel dissipation         |                           | Pch*2                    | 30          | W    |
| Channel temperature         |                           | Tch                      | 150         | °C   |
| Storage temperature         |                           | Tstg                     | −55 to +150 | °C   |

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. Value at  $T_C = 25$ °C

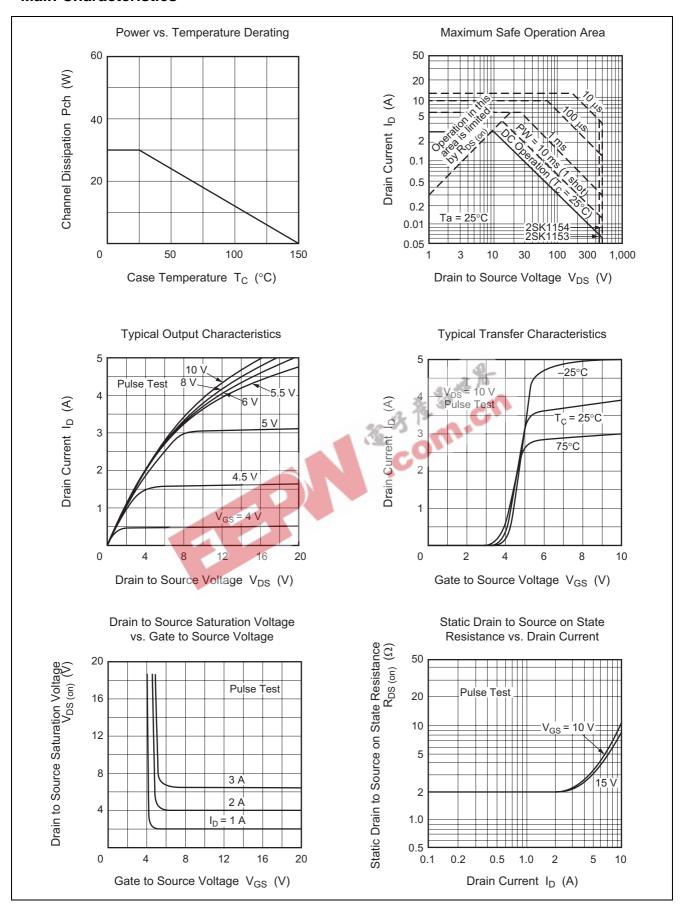
## **Electrical Characteristics**

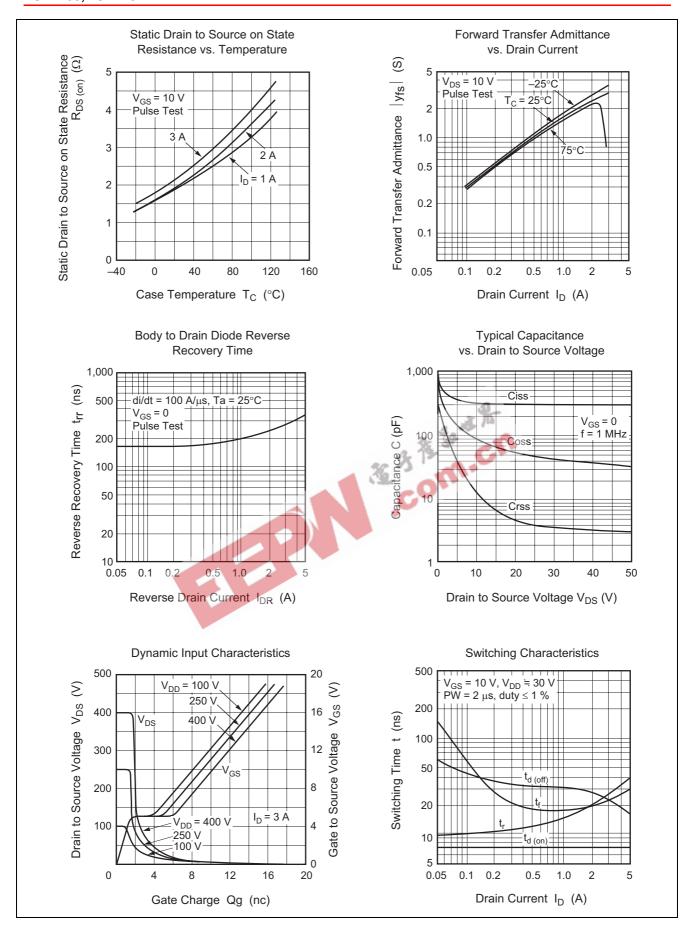
 $(Ta = 25^{\circ}C)$ 

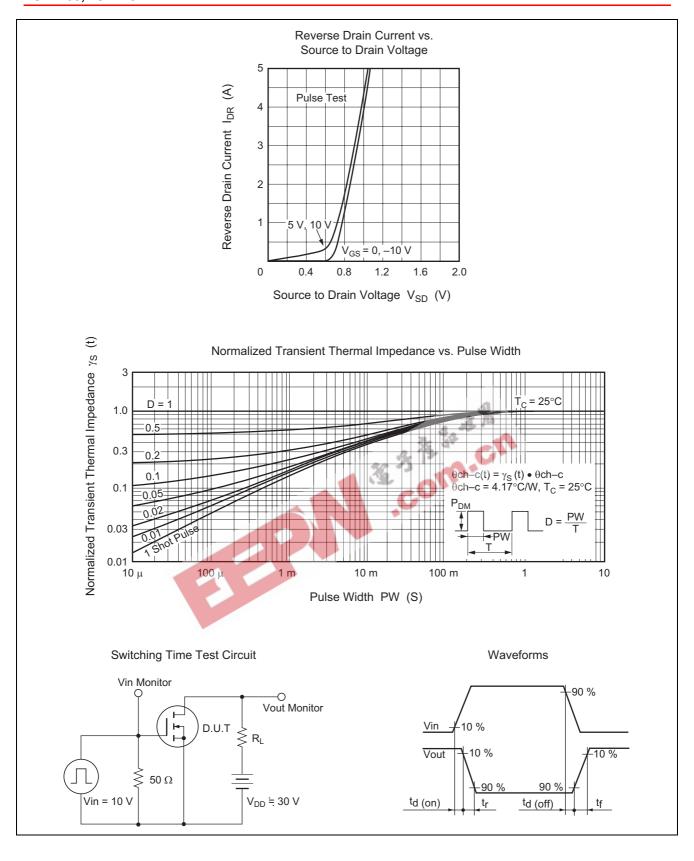
| Item                                 |         | Symbol               | Min            | Тур | Max | Unit | Test conditions                             |
|--------------------------------------|---------|----------------------|----------------|-----|-----|------|---|
| Drain to source                      | 2SK1153 | $V_{(BR)DSS}$        | 450            | _   | _   | V    | $I_D = 10 \text{ mA}, V_{GS} = 0$           |
| breakdown voltage                    | 2SK1154 |                      | 500            |     |     |      |   |
| Gate to source breakdowr             | voltage | $V_{(BR)GSS}$        | ±30            | 1   | _   | V    | $I_G = \pm 100 \ \mu A, \ V_{DS} = 0$       |
| Gate to source leak current          |         | I <sub>GSS</sub>     | _              | _   | ±10 | μΑ   | $V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$     |
| Zero gate voltage drain              | 2SK1153 | I <sub>DSS</sub>     | _              | - 6 | 250 | μΑ   | $V_{DS} = 360 \text{ V}, V_{GS} = 0$        |
| current                              | 2SK1154 |                      |                | 36  | , M | 1    | $V_{DS} = 400 \text{ V}, V_{GS} = 0$        |
| Gate to source cutoff voltage        |         | V <sub>GS(off)</sub> | 2.0            | 130 | 3.0 | ٧    | $I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$ |
| Static drain to source on            | 2SK1153 | R <sub>DS(on)</sub>  | ~ <del>-</del> | 2.0 | 2.8 | Ω    | $I_D = 2 A$ , $V_{GS} = 10 V^{*3}$          |
| state resistance                     | 2SK1154 |                      | 1-1            | 2.2 | 3.0 |      |   |
| Forward transfer admittance          |         | y <sub>fs</sub>      | 1.5            | 2.5 | _   | S    | $I_D = 2 A, V_{DS} = 10 V^{*3}$             |
| Input capacitance                    |         | Ciss                 |                | 330 | _   | pF   | $V_{DS} = 10 \text{ V}, V_{GS} = 0,$        |
| Output capacitance                   |         | Coss                 | _              | 90  | _   | pF   | f = 1 MHz                                   |
| Reverse transfer capacitance         |         | Crss                 | _              | 15  | _   | pF   |   |
| Turn-on delay time                   |         | t <sub>d(on)</sub>   | _              | 7   | _   | ns   | $I_D = 2 A$ , $V_{GS} = 10 V$ ,             |
| Rise time                            |         | t <sub>r</sub>       | _              | 20  | _   | ns   | $R_L = 15 \Omega$                           |
| Turn-off delay time                  |         | t <sub>d(off)</sub>  | _              | 30  | _   | ns   |   |
| Fall time                            |         | t <sub>f</sub>       | _              | 20  | _   | ns   |   |
| Body to drain diode forward voltage  |         | $V_{DF}$             | _              | 0.9 | _   | V    | $I_F = 3 A, V_{GS} = 0$                     |
| Body to drain diode reverse recovery |         | t <sub>rr</sub>      | _              | 300 | _   | ns   | $I_F = 3 A, V_{GS} = 0,$                    |
| time                                 |         |                      |                |     |     |      | $di_F/dt = 100 A/\mu s$                     |

Note: 3. Pulse test

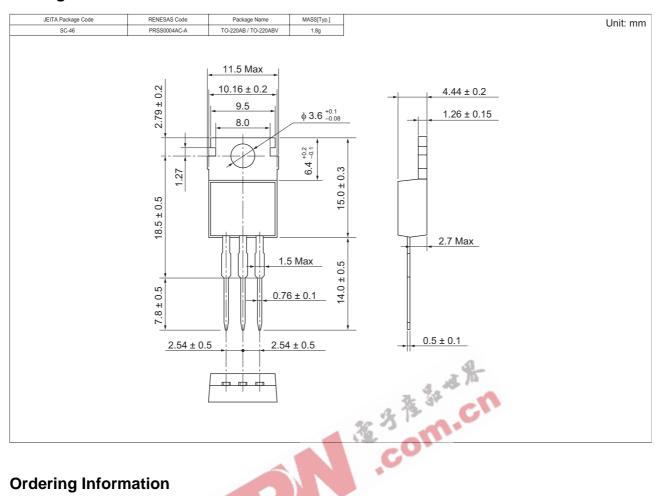
#### **Main Characteristics**







## **Package Dimensions**



## **Ordering Information**

| Part Name | Quantity | Shipping Container |
|-----------|----------|--------------------|
| 2SK1153-E | 500 pcs  | Box (Sack)         |
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